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## Outline

- Phase I and Phase II
  - Background
  - Sensing principle candidates
  - Laboratory tests
  - Field tests
- Phase III
  - Study on the property of sapphire fibers
  - Finalizing of the sensor structure
  - Silica-sapphire splicing technique
  - Optimization of optical system and data acquisition
  - Materials Selection
  - Probe Design
  - Field Testing





## Motivation

- Temperature sensor for harsh-environments:
  - Coal gasifier
  - Gas turbine
- Temperature measurement is critical for:
  - Gasifier start-up
  - Process optimization
    - Insulation wear vs. coal slag transition.
  - Event/failure detection
- Help make gasification cost-competitive
  - Reduce down-time
  - Improve operational efficiency





## Objective

#### • Objective:

To demonstrate the capability of an integrated sapphire optical temperature sensor through the development of sapphire based sensor assemblies and performance evaluation of the sensor on a full scale coal gasifier and a bench scale aero thermal turbine combustion rig.



## Background: challenges

- Coal gasifiers challenging harsh environment:
  - High temperatures: between 1100-1500°C.
  - Extreme corrosion:
    - coal slag
    - alkali vapors
    - transition metals





## P1&P2: Background

- Industrial need in high temperature measurement
- Review on existing technique
  - Non-optical: high temperature thermocouple, acoustic methods and gas-viscosity thermometry
  - Optical: remote pyrometry, thermal expansion thermometers, thermoluminescence thermometers and Rayleigh scattering thermometers
- Advantage of single crystal sapphire
  - Optical properties
  - Thermal-optic effects
  - Mechanical properties
  - Chemical inertness





## P1&P2: Sensing principle candidates

- Principles:
  - Extrinsic Fabry-Pérot Interferometric (EFPI)
  - Polarized-light interferometric sensor (PLIS)
  - Broadband Polarimetric Differential Interferometry (BPDI)
  - EFPI sapphire wafer sensor
- Possible sensor designs
- Algorithm principles
- Estimation on the affect of harsh environment
  - Blackbody Radiation
  - Corrosion





### P1&P2: Laboratory tests

- Sapphire fiber EFPI sensor
  - Too complicated to fabricate
  - Not suitable for industrial deployment
- Intensity based PLIS sensor
  - Structure not practical for industrial deployment
- Sapphire BPDI sensor
  - Free space structure has a high requirement for testing environment and low robustness
- Sapphire wafer EFPI sensor (chosen)
  - Compact, simple, robust and stable.





### P1&P2: Field tests

- Wabash field test of BPDI sensor
  - No test were performed due to numerous logistical problems
- TECO field tests of sapphire wafer EFPI sensor
  - First (2006-2007): ~210 days of sensor lifetime demonstrated
  - Second (2006): ~20 days of sensor survival
  - Third (2007-2008): ~9 days of sensor survival
- Issues addressed: packaging and sensor long-term stability



## P3: Study on the property of sapphire fibers

• Study on contamination and decay of sapphire fiber











• Thermal fusion cap sealing technique









• Tube sealing sensor







• Addressing of multi-surface interference issue







• Side polished sensor design







• Side polished sensor improvement









43 days lab test passed





## P3: Silica-sapphire splicing technique

- Choosing the right multimode fiber:
  - Nufern 100/140 MMF
  - OFS 105/125 MMF
- Attempt of angle-polished design to remove void in fiber core





## P3: Silica-sapphire splicing technique

• Sapphire-100/140 MMF-105/125 MMF splicing scheme



- Splicing point thermal endurance characterization
  - 600°C as the maximum surviving temperature
  - 400°C as the suggested working temperature





# P3: Optimization of optical system and data acquisition

• Fiber system optimization



105/125 MMF for all system, including coupler and feedthrough. Effectively reduced loss and extended lifetime of sensors.



# P3: Optimization of optical system and data acquisition

• Data Acquisition Software



Totally rewritten and fully tested. Now more stable, more flexible, more robust, jumping free in demodulation, and field-communication ready.



## P3: Probe packaging design

- Based on the corrosion testing
  - Design utilized:



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### P3: Materials Testing and selection

• Materials testing for corrosion from coal slag



## First blank probe results







### P3: Blank probe field test #1 results

• Probe installed at Eastman Chemical on





### P3: Blank probe field test #1

• Failure analysis done





### Progress updates: blank probe thermal modeling

- Sapphire tube surrounded by high chrome paste experienced stresses ranging from 1.5GPa-5GPa (220ksi-725ksi).
- Highest stress concentrations in corners.
- Yield strength of sapphire at room temperature is around 400MPa (58ksi).
- Yield strength drops to 325MPa (47ksi) at 1000°C.







### P3: Blank probe field test #2

- Redesigned based on field test #1
  - Moved chrome paste to cold area



Alumina adhesive





### P3: Blank probe field test #2 results

• Probe installed at Eastman on







#### P3: Blank probe field test #2 results







### P3: Final Field test probe assembly



tube



Probe packaging components



### P3: Final field test probe testing



Sensor #	<b>S</b> 10	<b>S</b> 11	S14	\$15	<b>S</b> 16	S18
Original total intensity (a.u.)	3193	3277	1789	3233	2377	3120
Total intensity after annealing	36%	65%	40%	62%	52%	57%
Original fringe contrast	0.232	0.192	0.204	0.184	0.193	0.221
Fringe contrast after annealing	85%	100%	80%	97%	85%	91%

## Final packaging prior to flange attachment

Sensor stability





### Summary

- Difficult environment to operate and experiment in:
  - Developments achieved
    - Long term sensor stability
      - Elevated T
    - Accurate & stable High T measurement
      - Harsh environment
    - Environment-material interaction understanding
      - Coal slag
      - Packaging
      - Temperature
    - Sapphire temperature instrumentation packing
      - High T
      - High T & corrosive environment



## Thank you

• Questions?

